



WT32C3-S1

WT32C3-S2

Datasheet

2.4GHz WiFi (802.11b/g/n) and Bluetooth 5 module

Built around ESP32-C3 series of SoCs, RISC-V single-core microprocessor

4MB flash

On-board PCB antenna or external antenna connector



V1.0.0

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About this document

This document provides users with the technical specifications for WT32C3-S1 and WT32C3-S2.

Document updates

Please visit Wireless-Tag's official website to download the latest version of the document.

Revision history

Please go to the document revision history page to view the revisions of the document.

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Statement

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Revision History

No.	Version	Changes	Change (+/-) Descriptions	Author	Date
1	V1.0.0	C	Created the document	Wang	January 13, 2021

*Changes: C——create, A——add, M——modify, D——delete



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1 Overview

WT32C3-S1 and WT32C3-S2 are general-purpose Wi-Fi and Bluetooth low energy (Bluetooth LE) modules, which are embedded wireless network control modules with low power consumption and high cost performance. It can meet the needs of IoT applications such as smart grid, building automation, security, smart home, and telemedicine.

WT32C3-S1 and WT32C3-S2 modules are equipped with 4 MB external SPI flash. WT32C3-S1 adopts PCB onboard antenna, WT32C3-S2 adopts connector to connect external antenna.

The WT32C3-S1 and WT32C3-S2 modules use the ESP32-C3 chip. The ESP32-C3 chip is equipped with a RISC-V 32-bit single-core processor with a main frequency of up to 160MHz.

The module supports for the standard IEEE802.11 b/g/n protocol and Bluetooth Low Energy 5.0 (Bluetooth LE): Bluetooth 5, Bluetooth mesh. The module can be used to help Bluetooth pairing and network connection to existing devices, or build an independent network controller.

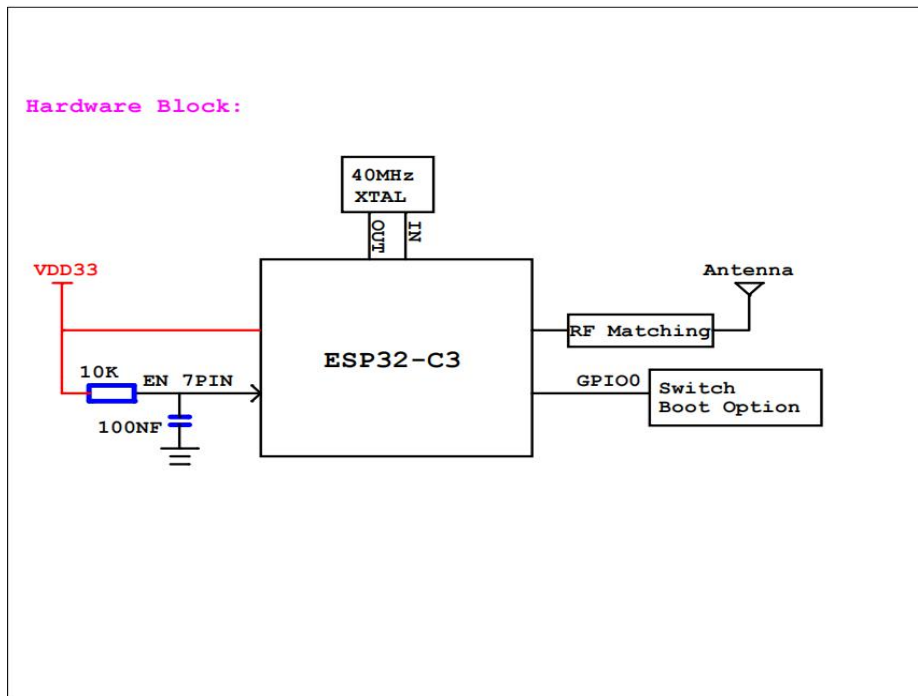
2 Features

- QFN32 package
- On-board PCB antenna
- Operating voltage: 3.3V
- Operating ambient temperature: -20-85°C
- ESP32-C3 chip embedded, 32-bit RISC-V single-core microprocessor, up to 160MHz
 - SRAM 400KB
 - RTC SRAM 8KB
 - ROM 384KB
- Embedded Flash 4MB
- System
 - WIFI
 - IEEE 802.11 b/g/n protocol
 - 1T1R mode with data rate up to 150 Mbps
 - WIFI @2.4 GHz, support for WEP/WPA-PSK/WPA2-PSK security mode
 - Frame aggregation (TX/RX A-MPDU, RX A-MSDU)
 - BLE
 - Bluetooth Low Energy 5.0(Bluetooth LE): Bluetooth 5, Bluetooth mesh
 - Speed: 125 Kbps, 500 Kbps, 1 Mbps, 2 Mbps
 - Advertising Extensions
 - Multiple Advertisement Sets
 - Channel Selection Algorithm #2
 - Hardware
 - Support for GPIO, SPI, UART, I2C, I2S, infrared transceiver, LED PWM controller, USB JTAG interface, general DMA controller, TWAITM controller (compatible with ISO11898-1), temperature sensor, SAR ADC
 - Support for STA/AP/STA+AP mode
 - Support for remote OTA

3 Hardware Specifications

3.1 Block Diagram

Figure 1 Block Diagram



3.2 Pin Descriptions

Figure 2 Pin Layout

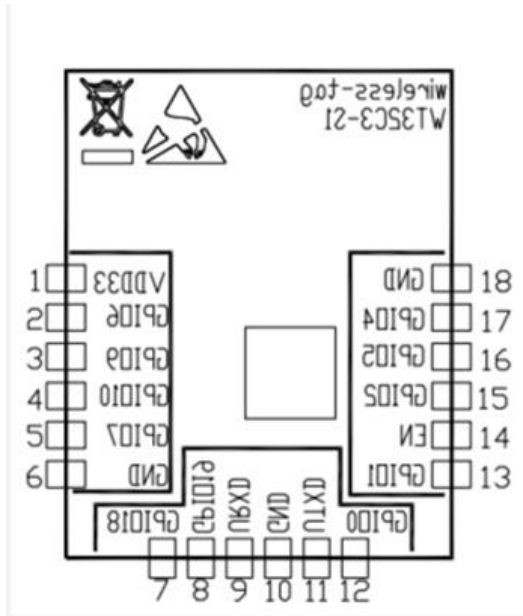


Table 1 Pin Definitions and Descriptions

Pin	Name	Description
1	VDD33	3.3V power supply; The output current delivered by the external power supply is recommended to be above 500mA.
2	GPIO6	GPIO6,FSPICLK,MTCK
3	GPIO9	GPIO9
4	GPIO10	GPIO10,FSPICS0
5	GPIO7	GPIO7,FSPID,MTDO
6	GND	GND
7	GPIO18	GPIO18,USB_D-
8	GPIO19	GPIO18,USB_D+
9	URXD	GPIO20,U0RXD
10	GND	GND
11	UTXD	GPIO21,U0TXD
12	GPIO0	GPIO0.ADC1_CH0,XAL_32K_P
13	GPIO1	GPIO0.ADC1_CH1,XAL_32K_N
14	CHIP_EN	Chip Enable pin: High level: on, enables the chip. Low level: off, low current. Note: Do not leave the EN pin floating.

Pin	Name	Description
15	GPIO2	GPIO2,ADC1_CH2,FSPIQ
16	GPIO5	GPIO5,ADC2_CH0,FSPIWP,MTDI
17	GPIO4	GPIO4,ADC1_CH4,FSPIHD,MTMS
18	GND	GND

3.3 Strapping Pins

ESP32-C3 series has three strapping pins.

- GPIO2
- GPIO8
- GPIO9

Software can read the strapping values of these pins in “GPIO_STRAPPING” register.

During the chip’s system reset(power-on reset, RTC watchdog reset, brownout reset, analog super watchdog reset, crystal clock glitch detection reset), the latches of the strapping pins sample the voltage level as strapping bits of “0” or “1”, and hold these bits until the chip is powered down or shut down.

By default, GPIO9 is connected to the internal pull-up resistor. If GPIO9 is not connected or connected to an external high-impedance circuit, the latched bit value will be “1”.

To change the strapping bit values, you can apply the external pull-down/pull-up resistances, or use the host MCU’s GPIOs to control the voltage level of these pins when powering on ESP32-C3 family.

After reset, the strapping pins work as normal-function pins.

Refer to Table 2 for a detailed boot-mode configuration of the strapping pins.

Note:

Some pins have been internally pulled up, please refer to the schematic diagram.

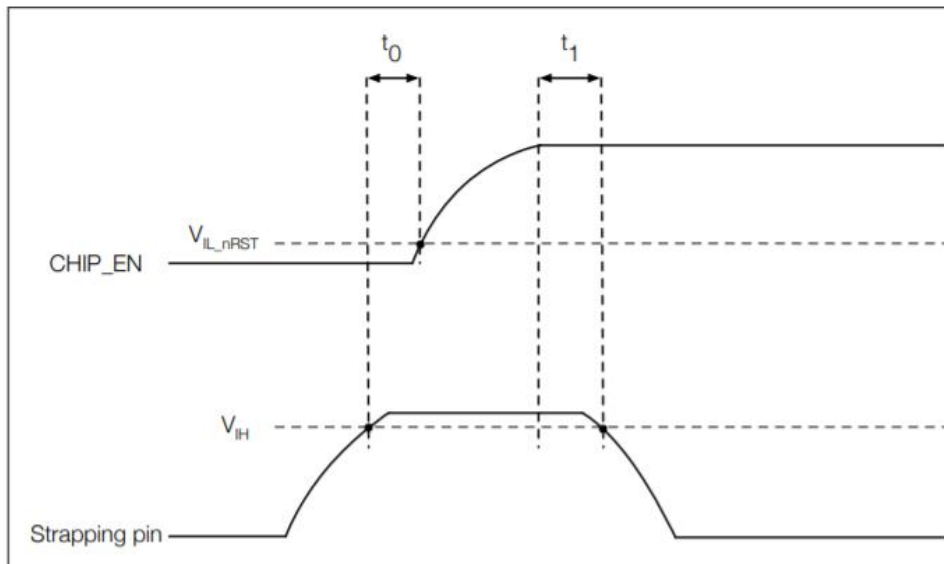
Table 2 Strapping Pins

Booting Mode ¹			
Pin	Default	SPI Boot	Download Boot
GPIO2	N/A	1	1
GPIO8	N/A	Don't care	1
GPIO9	Internal pull-up	1	0
Enabling/Disabling ROM Code Print During Booting			

Pin	Default	Functionality
GPIO8	N/A	When the value of eFuse field UART_PRINT_CONTROL is 0, print is enabled and not controlled by GPIO8. 1, if GPIO8 is 0, print is enabled; if GPIO8 is 1, it is disabled. 2, if GPIO8 is 0, print is disabled; if GPIO8 is 1, it is enabled. 3, print is disabled and not controlled by GPIO8.
Parameter Descriptions of Setup and Hold Times for the Strapping Pin		
Parameter	Description	Min
t ₀	Setup time before CHIP_EN goes from low to high	0ms
t ₁	Hold time after CHIP_EN goes high	3ms

Figure 3 shows the setup and hold times for the strapping pin before and after the CHIP_EN signal goes high.

Figure 3 Setup and Hold Times for the Strapping Pin



Note:

1. The strapping combination of GPIO8 = 0 and GPIO9 = 0 is invalid.

4 Electrical Characteristics

4.1 Absolute Maximum Ratings

Stresses above those listed in Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

4.2 Recommended Operating Conditions

Table 3 Operating Conditions

Symbol	Parameter		Min	Typ	Max	Unit
VDD	Power supply voltage		3.0	3.3	3.6	V
I _{VDD}	Current delivered by external power supply		0.5	-	-	A
T _A	Ambient temperature	85°C version	-40	-	85	°C
		105°C version			105	
Humidity	Humidity condition		-	-	85	%RH

4.3 Current Consumption

Table 4 Current Consumption Depending on RF Modes

Work mode	Description		Peak (mA)
Active(RF working)	TX	802.11b, 1 Mbps, @17dBm	384
		802.11g, 54 Mbps, @16.4dBm	287
		802.11n, HT20, MCS 7, @16 dBm	275
		802.11n, HT40, MCS 7, @16 dBm	260
	RX	802.11b/g/n, HT20	83
		802.11n, HT40	86

Note:

Ambient temperature, 3.3V power supply, TX continues mode, DC power accuracy: 100 μA.

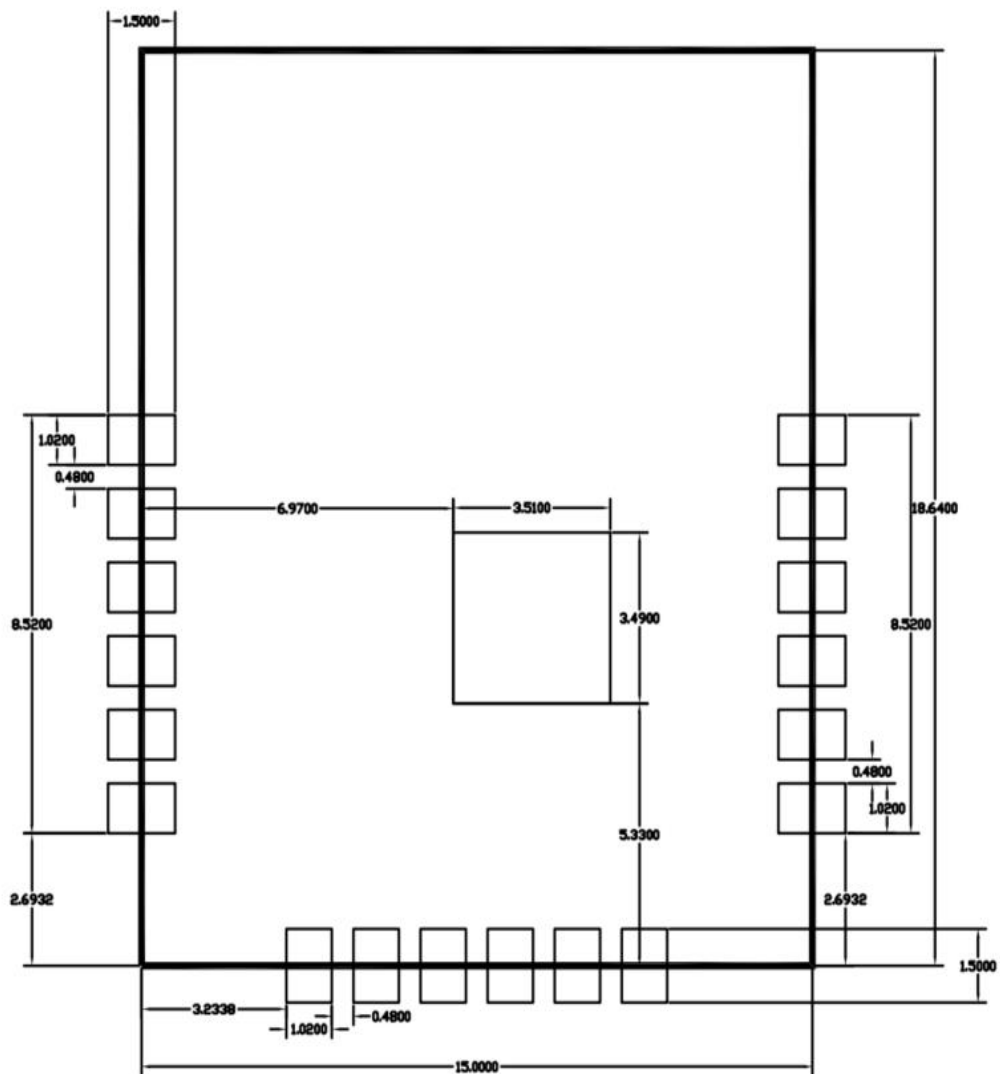
**Table 5 Current Consumption Depending on Work Modes**

Work mode	Description		Typical value
Modem-sleep	The CPU is powered on	160MHz	25. 8mA
		80MHz	22. 7mA
Light-sleep			0. 3mA
Deep-sleep			14uA
Power off	EN is set to low level		0

5 Application Note

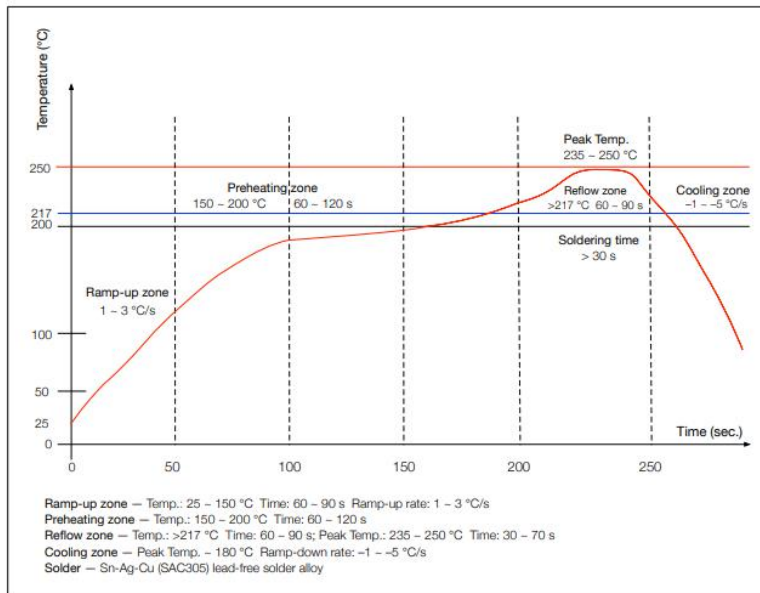
5.1 Module Dimensions

Figure 4 Module Dimensions



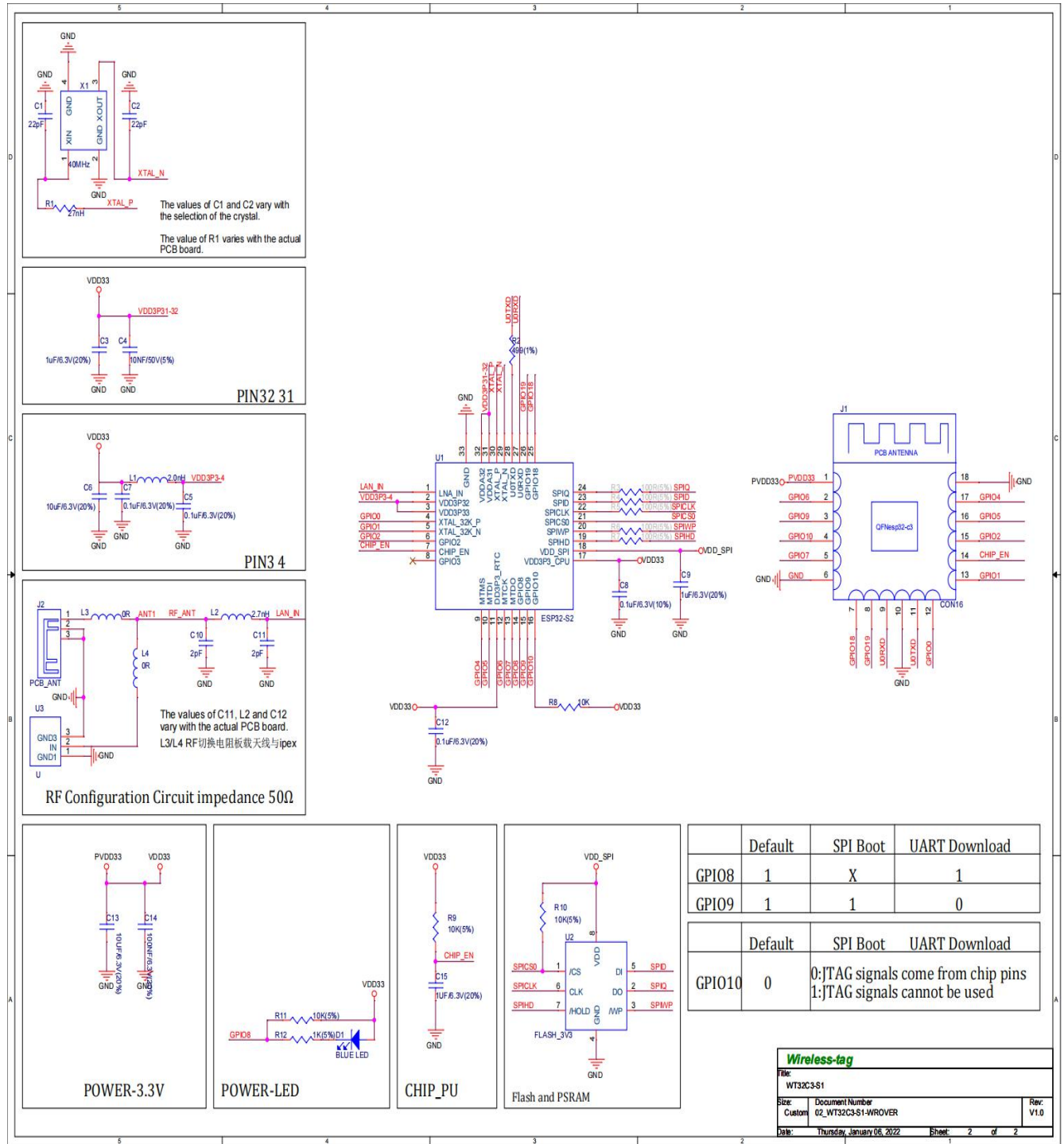
5.2 Reflow Profile

Figure 5 Reflow profile



5.3 Module Schematics

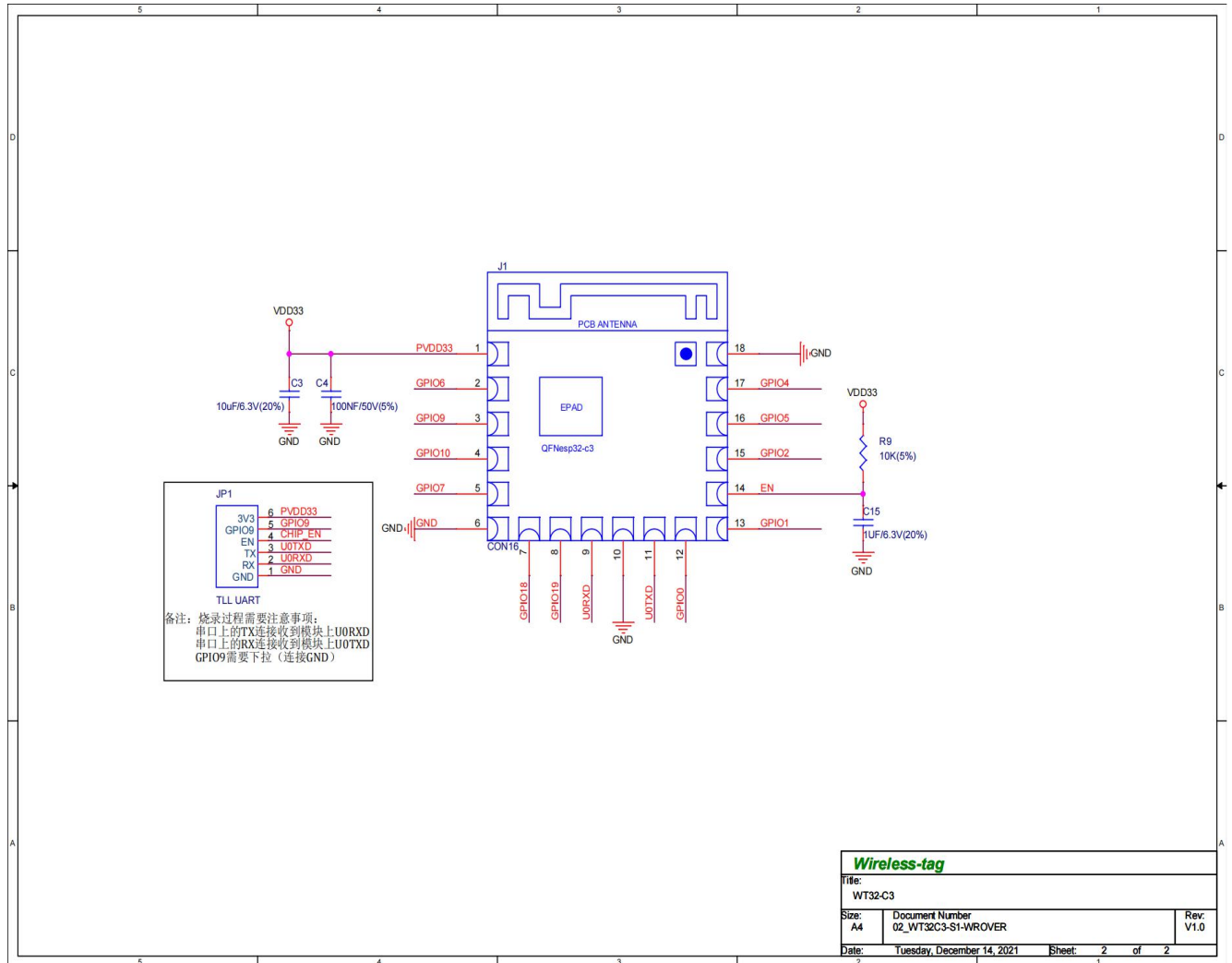
Figure 6 Module Schematics



5.4 Peripheral Schematic

This is the typical application circuit of the module connected with peripheral components (for example, power supply, antenna, reset button, JTAG interface, and UART interface).

Figure 7 Application Circuit



- Soldering the EPAD to the ground of the base board is not a must, though doing so can get optimized thermal performance. If you do want to solder it, please ensure that you apply the correct amount of soldering paste.
- To ensure the power supply to the ESP32-C3 family chip is stable during power-up, it is advised to add an RC delay circuit at the EN pin. The recommended setting for the RC delay circuit is usually $R = 10\text{ k}\Omega$ and $C = 1\text{ }\mu\text{F}$. However, specific parameters should be adjusted based on the power-up timing of the module and the power-up and reset sequence timing of the chip.



6 Product Trial

- Sales email: sales@wireless-tag.com
- Technical support email: technical@wireless-tag.com

Federal Communication Commission Statement (FCC, U.S.)

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

(1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

FCC Caution:

Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment.

FCC Radiation Exposure Statement:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

IMPORTANT NOTES

Co-location warning:

This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.

OEM integration instructions:

This device is intended only for OEM integrators under the following conditions:

The transmitter module may not be co-located with any other transmitter or antenna. The module shall be only used with the external antenna(s) that has been originally tested and certified with this module.

As long as the conditions above are met, further transmitter test will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

Validity of using the module certification:

In the event that these conditions cannot be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization for this module in combination with the host

equipment is no longer considered valid and the FCC ID of the module cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

End product labeling:

The final end product must be labeled in a visible area with the following: "Contains Transmitter Module FCC ID: 2AFOS-WT32C3-SX".

Information that must be placed in the end user manual:

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information/warning as show in this manual.

Integration instructions for host product manufactures according to KDB 996369 D03 OEM Manual v01

2.2 List of applicable FCC rules

FCC Part 15 Subpart C 15.247 & 15.207 & 15.209

2.3 Specific operational use conditions

The module is a Bluetooth module with WiFi & BLE 2.4G function.

WiFi Specification:

Operation Frequency: 2412~2462MHz

Number of Channel: 11

Modulation: DSSS, OFDM

Type: PCB Antenna

Gain: 2 dBi

BLE Specification:

Operation Frequency: 2402~2480MHz

Number of Channel: 40

Modulation: GFSK

Type: PCB Antenna

Gain: 2 dBi

The module can be used for mobile or applications with a maximum 2dBi antenna. The host manufacturer installing this module into their product must ensure that the final composit product complies with the FCC requirements by a technical assessment or evaluation to the FCC rules, including the transmitter operation. The host manufacturer has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which

integrates this module. The end user manual shall include all required regulatory information/warning as show in this manual.

2.4 Limited module procedures

Not applicable.

2.5 Trace antenna designs

Not applicable. The module has its own antenna, and doesn't need a host's printed board microstrip trace antenna etc.

2.6 RF exposure considerations

The module must be installed in the host equipment such that at least 20cm is maintained between the antenna and users' body; and if RF exposure statement or module layout is changed, then the host product manufacturer required to take responsibility of the module through a change in FCC ID or new application. The FCC ID of the module cannot be used on the final product. In these circumstances, the host manufacturer will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization

2.7 Antennas

Antenna Specification are as follows:

Type: PCB Antenna

Gain: 2 dBi

This device is intended only for host manufacturers under the following conditions: The transmitter module may not be co-located with any other transmitter or antenna; The module shall be only used with the internal antenna(s) that has been originally tested and certified with this module. The antenna must be either permanently attached or employ a 'unique' antenna coupler.

As long as the conditions above are met, further transmitter test will not be required. However, the host manufacturer is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.)

2.8 Label and compliance information

Host product manufacturers need to provide a physical or e-label stating "Contains Transmitter Module

FCC ID: 2AFOS-WT32C3-SX" with their finished product.

2.9 Information on test modes and additional testing requirements

BLE

Operation Frequency: 2402~2480MHz

Number of Channel: 40

Modulation: GFSK

WIFI

Operation Frequency: 2412~2462MHz

Number of Channel: 11

Modulation: DSSS, OFDM

Host manufacturer must perform test of radiated & conducted emission and spurious emission, etc according to the actual test modes for a stand-alone modular transmitter in a host, as well as for multiple simultaneously transmitting modules or other transmitters in a host product. Only when all the test results of test modes comply with FCC requirements, then the end product can be sold legally.

2.10 Additional testing, Part 15 Subpart B disclaimer

The modular transmitter is only FCC authorized for FCC Part 15 Subpart C 15.247 & 15.207 & 15.209 and that the host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. If the grantee markets their product as being Part 15 Subpart B compliant (when it also contains unintentional radiator digital circuitry), then the grantee shall provide a notice stating that the final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed.